Electronics Engineer

75000 Paris · 0 à 1 an d'expérience · Réf. 2607071707

Ma recherche

Contrat recherché : Tout contrat
Zone : Ile de France
Mobilité : sur toute la région
Rémunération : a étudier
Secteur : Batiment

Formations

12/2023 — Bac +5 — INP ENSEEIHT
Master Of Science – Electronic Systems for Embedded and Communicating Applications
12/2019 — Bac +3 — REVA University
Bachelor of Technology – Electronics and Communications

Expériences professionnelles

09/2024 - 11/2024 — Application Engineer – System on Chip
Provided customer support for Network on Chip (NoC) solutions, trained on FlexNoC tool, performed architectural analysis and debugging, collaborated with R&D to resolve tool related issues, and used AMBA protocols (AXI, AHB, APB, OCP).
02/2023 - 08/2023 — Firmware Engineer - Internship
Contributed to the design, development, and testing of firmware for logging tools using DSP techniques. Supported the integration and validation of firmware. Collaborated with cross functional teams to ensure product quality and performance standards.

Langues

French (notions), English (courant)

Atouts

FPGA Design, VHDL Programming, Xilinx Vivado (Nexys A7), Embedded Systems (pic18f, Arduino UNO), Embedded C, MPLAB, UVM, MATLAB, Python, C, HTML, Web3, Microsoft Office Pack, JIRA, FlexNoC, Techlog, Cadence, LTSpice, Advanced Design System (ADS), AI skills – Knowledge of AI agents, LLM, prompting, Self motivated, rigorous, autonomous, Interpersonal skills, Technical support – troubleshooting, writing, copywriting

Fiche anonyme — l'identité et les coordonnées du candidat sont communiquées aux recruteurs qui en font la demande sur pmebtp.com.